

Description

The SM4286T9RL uses advanced trench technology

to provide excellent $R_{\text{DS}(\text{ON})},$ low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 100V I_D = 20A

 $R_{DS(ON)} < 87 \, m\Omega @ V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply

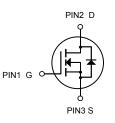
Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)		
SM4286T9RL	TO252-2L	20N10 XXYY	2500		

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	ol Parameter Rating		Units	
Vds	Drain-Source Voltage 100		V	
Vgs	Gate-Source Voltage	±20	V	
I₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	20	A	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	10	А	
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	5	А	
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	3.4	А	
Ідм	Pulsed Drain Current ²	30	А	
EAS	Single Pulse Avalanche Energy ³	6.1	mJ	
las	Avalanche Current	15	А	
P₀@Tc=25°C	Total Power Dissipation ⁴	34.7	W	
P _D @T _A =25°C	Total Power Dissipation ⁴	2	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
Reja	Thermal Resistance Junction-ambient ¹	62	°C/W	
Rejc	Thermal Resistance Junction-Case ¹	3.6	°C/W	





N-Channel MOSFET



Electrical Characteristics (T_J=25 $^{\circ}$ C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V	
$\triangle BV_{DSS} / \triangle T$	BVDSS Temperature Coefficient	Reference to 25° C , I _D =1mA		0.098		V/°C	
Basian	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =10A		80	87	mΩ	
Rds(on)		V _{GS} =4.5V , I _D =8A		95	105	mΩ	
V _{GS(th)}	Gate Threshold Voltage		1.0		2.5	V	
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	−−−V _{GS} =V _{DS} , I _D =250uA		-4.57		mV/°C	
I	Droin Source Lookage Current	V _{DS} =80V , V _{GS} =0V , T _J =25°C			1	uA	
IDSS	Drain-Source Leakage Current	V _{DS} =80V , V _{GS} =0V , T _J =55°C			5	uA	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =10A		13		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2		Ω	
Qg	Total Gate Charge (10V)			26.2			
Qgs	Gate-Source Charge	V _{DS} =80V , V _{GS} =10V , I _D =10A		4.6		nC	
Q_{gd}	Gate-Drain Charge			5.1			
T _{d(on)}	Turn-On Delay Time			4.2			
Tr	Rise Time	V_{DD} =50V , V_{GS} =10V , R_{G} =3.3 Ω		8.2			
T _{d(off)}	Turn-Off Delay Time	I _D =10A		35.6		ns	
T _f	Fall Time			9.6			
Ciss	Input Capacitance			1535			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		60		pF	
Crss	Reverse Transfer Capacitance			37			

Diode Characteristics

Symbol	Parameter	Conditions		Тур.	Max.	Unit
ls	Continuous Source Current ^{1,5}	V/ OV/ Force Current			20	А
Ism	Pulsed Source Current ^{2,5}	$V_G = V_D = 0V$, Force Current			30	А
V _{SD}	Diode Forward Voltage ²	ss=0V , Is=1A , Tյ=25°C			1.2	V
t _{rr}	Reverse Recovery Time			37		nS
Qrr	Reverse Recovery Charge	=10A , dl/dt=100A/µs , T _J =25°C		27.3		nC

Note :

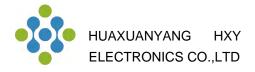
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS}=11A

4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

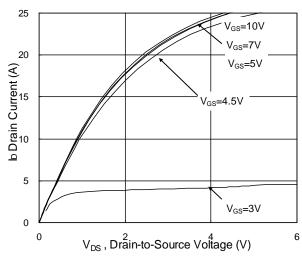


Fig.1 Typical Output Characteristics

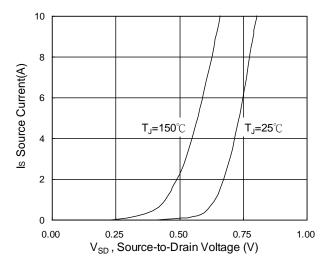


Fig.3 Forward Characteristics Of Reverse

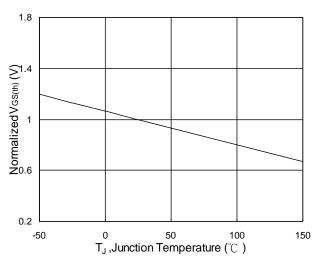


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

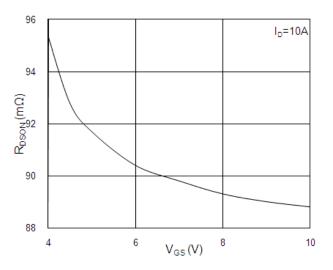


Fig.2 On-Resistance vs. Gate-Source

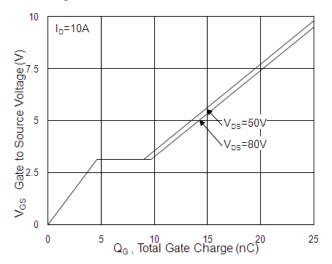


Fig.4 Gate-Charge Characteristics

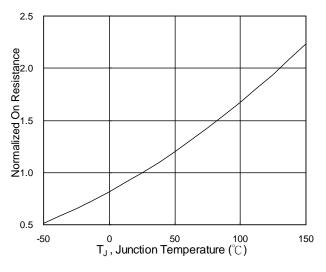
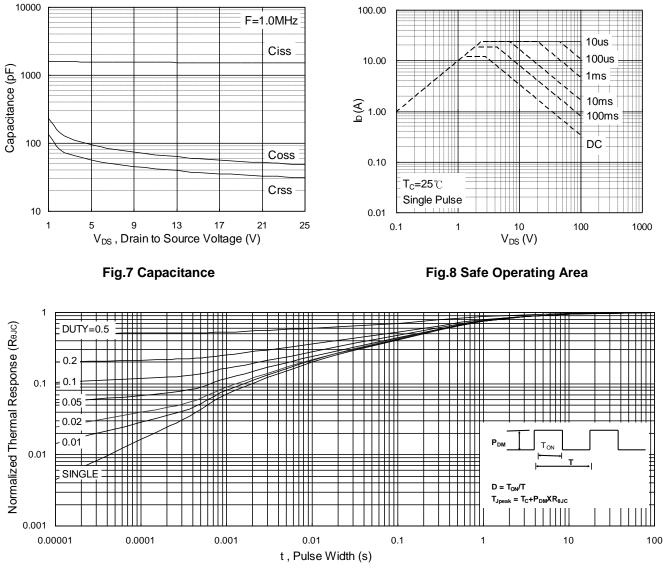


Fig.6 Normalized RDSON vs. TJ







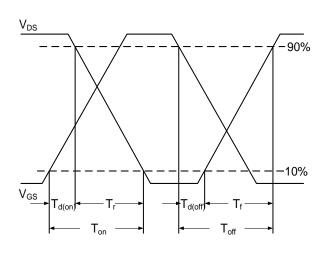


Fig.10 Switching Time Waveform

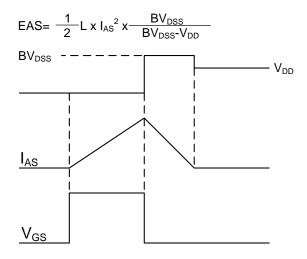
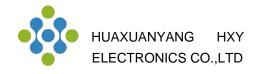
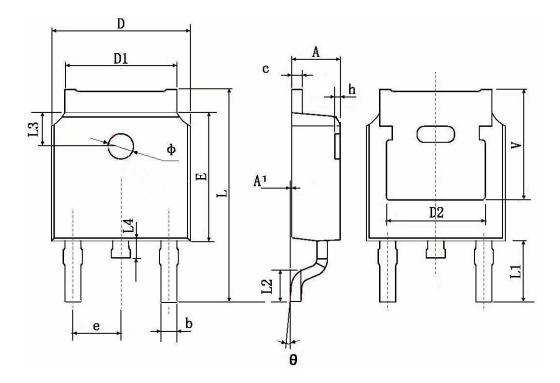


Fig.11 Unclamped Inductive Switching Waveform



TO-252-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
с	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	0.483 TYP.		0.190	TYP.		
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900	TYP.	0.114 TYP.			
L2	1.400	1.700	0.055	0.067		
L3	1.600	0 TYP. 0.063 TYP.		1.600 TYP.		3 TYP.
L4	0.600	1.000	0.024	0.039		
Φ	1.100	1.300	0.043	0.051		
θ	0°	8°	0 °	8°		
h	0.000	0.300	0.000	0.012		
V	5.350) TYP.	0.211 TYP.			



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